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February 4, 2004

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Attorney Reference: TAI 131 D1



Robert H. Berdo, Jr.
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Qixia Zhana. Pat. Agent (China)

Steven M. Rabin

Tobluary 4,

**Box: PATENT APPLICATION** 

Assistant Commissioner for Patents

Washington, D.C. 20231

Re:

New Divisional Patent Application of: Takaaki SASAKI

Title: SEMICONDUCTOR PACKAGE FOR THREE-DIMENSIONAL MOUNTING,

FABRICATION METHOD THEREOF, AND SEMICONDUCTOR DEVICE

Sir:

Please find attached hereto an application for patent which includes:

[x] Utility Patent Application Transmittal Form (in duplicate)

[x] Specification, Claims and Abstract (37 pages)

[x] Eight (8) Sheets of Formal Drawings (Fig. 1 through Fig. 15)

[x] Copy of Inventor's Declaration and Power of Attorney (3 Pages)

[x] Copy of Recorded Assignment document (4 Pages)

[x] Information Disclosure Statement and PTO-1449

[x] Preliminary Amendment (7 Pages)

[x] Fee (see formula below) Check No. 13869 enclosed

The rights of priority are claimed under 35 U.S.C. § 119 of Japanese Application No. 2000-351704, filed November 17, 2000 (priority document previously submitted).

In the event there is attached hereto no check, or a check for an insufficient amount, please charge the fee to our Account No. 18-0002 and notify us accordingly.

February 4, 2004

Date

Robert H. Berdo, Jr.

Registration No. 38,075

Respectfully submitted

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RHB:crh